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PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

June 25, 2010

Applicants: Katsuyuki TSUCHIDA et al

Title: COPPER ELECTROLYTIC SOLUTION CONTAINING AS ADDITIVE
COMPOUND HAVING SPECIFIC SKELETON, AND
ELECTROLYTIC COPPER FOIL MANUFACTURED THEREWITH

Serial No.: 10/588 686

Group: 1795

Confirmation No.: 9917\

Filed: August 7, 2006

Examiner: Wong

International Application No.: PCT/JP2005/022662

International Filing Date: December 9, 2005

Atty. Docket No.: 4700.P0335US

Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Herewith is an amendment in the above-identified application.

[] Applicant claims small entity status. See 37 CFR 1.27.

[] The additional filing fee has been calculated as shown below:

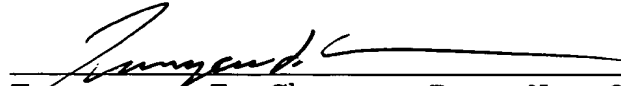
For	No. Filed	No. Extra	(X) LG Entity	RATE	() SM Entity	Fee
Total Claims	(3 - 20 = 0)		x	\$ 52.00	x \$ 26.00	
Indep. Claims	(1 - 3 = 0)		x	\$220.00	x \$110.00	
[] Multiple Dep. Claim			+	\$390.00	+	\$195.00
* * * TOTAL FILING FEE * * *						\$ 0.00

[] Pursuant to 37 CFR 1.136(a), please extend the shortened period
for response by month(s). The extension fee is: \$.


[] A Check for \$ is enclosed to cover fees.

[X] Please credit any overpayment, or charge any additional filing
fee required under 37 CFR 1.16 or 1.17 by this communication,
to Deposit Account No. 06-1382.

TFC/smd


Terryence F. Chapman Reg. No. 32 549-----
CERTIFICATE OF MAILINGI hereby certify that this correspondence is being deposited
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Alexandria, VA 22313-1450, on June 25, 2010.

130.10/08


Terryence F. Chapman